

3.3V 'SpreadTrak' Zero Delay Buffer

General Features

- 10 MHz to 133- MHz operating range, compatible with CPU and PCI bus frequencies.
- Zero input output propagation delay.
- Multiple low-skew outputs.
 - Output-output skew less than 250 ps.
 - Device-device skew less than 700 ps.
 - One input drives 9 outputs, grouped as 4 + 4
 + 1 (ASM5P23S09A).
 - One input drives 5 outputs (ASM5P23S05A).
- Less than 200 ps cycle-to-cycle jitter is compatible with Pentium[®] based systems.
- Test Mode to bypass PLL (ASM5P23S09A only, refer Select Input Decoding Table).
- Available in 16-pin, 150-mil SOIC, 4.4 mm TSSOP, and 150-mil SSOP packages (ASM5P23S09A) or in 8-pin, 150-mil SOIC package (ASM5P23S05A).
- 3.3V operation, advanced 0.35µ CMOS technology.
- 'SpreadTrak'.

Functional Description

ASM5P23S09A is a versatile, 3.3V zero-delay buffer designed to distribute high-speed clocks with Spread Spectrum capability. It is available in a 16-pin package. The ASM5P23S05A is the eight-pin version of the ASM5P23S09A. It accepts one reference input and drives out five low-skew clocks.

The -1H version of the ASM5P23SXXA operates at up to

133- MHz frequencies, and has higher drive than the -1 devices. All parts have on-chip PLLs that lock to an input clock on the REF pin. The PLL feedback is on-chip and is obtained from the CLKOUT pad.

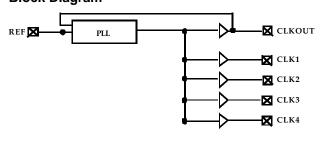
The ASM5P23S09A has two banks of four outputs each, which can be controlled by the Select inputs as shown in the Select Input Decoding Table. If all the output clocks are not required, Bank B can be three-stated. The select input also allows the input clock to be directly applied to the outputs for chip and system testing purposes.

Multiple ASM5P23S09A and ASM5P23S05A devices can accept the same input clock and distribute it. In this case the skew between the outputs of the two devices is guaranteed to be less than 700ps.

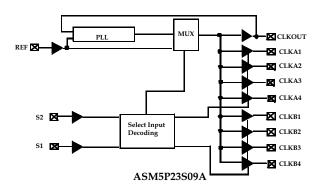
All outputs have less than 200 ps of cycle-to-cycle jitter. The input and output propagation delay is guaranteed to be less than 250 ps, and the output to output skew is guaranteed to be less than 250ps.

The ASM5P23S09A and the ASM5P23S05A are available in two different configurations, as shown in the ordering information table. The ASM5P23SXXA-1 is the base part. The ASM5P23SXXA-1H is the high drive version of the -1 and its rise and fall times are much faster than -1 part.

Block Diagram



ASM5P23S05A





Select Input Decoding for ASM5P23S09A

| S2 | S1 | Clock A1 - A4 | Clock B1 - B4 | CLKOUT 1 | Output Source | PLL |
|----------|----|---------------|---------------|----------|---------------|-----------|
| | | | | | | Shut-Down |
| 0 | 0 | Three-state | Three-state | Driven | PLL | N |
| 0 | 1 | Driven | Three-state | Driven | PLL | N |
| 1 | 0 | Driven | Driven | Driven | Reference | Υ |
| ell Loom | 1 | Driven | Driven | Driven | PLL | N |

Notes:

1. This output is driven and has an internal feedback for the PLL. The load on this output can be adjusted to change the skew between the reference and the output.

Zero Delay and Skew Control

All outputs should be uniformly loaded to achieve Zero Delay between input and output. Since the CLKOUT pin is the internal feedback to the PLL, its relative loading can adjust the input-output delay.

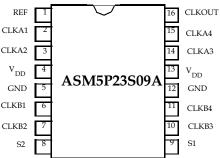
For applications requiring zero input-output delay, all outputs, including CLKOUT, must be equally loaded. Even if CLKOUT is not used, it must have a capacitive load equal to that on other outputs, for obtaining zero-input-output delay.

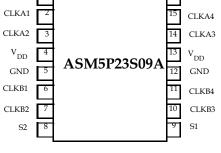
SpreadTrak

Many systems being designed now utilize a technology called Spread Spectrum Frequency Timing Generation. ASM5P23S09A and ASM5P23S05A are designed so as not to filter off the Spread Spectrum feature of the Reference input, assuming it exists. When a zero delay buffer is not designed to pass the Spread Spectrum feature through, the result is a significant amount of tracking skew which may cause problems in the systems requiring synchronization.



Pin Configuration









Pin Description for ASM5P23S09A

| Pin # | Pin Name | Description |
|------------|---------------------|--|
| 1 | REF ² | Input reference frequency, 5V tolerant input |
| 2 | CLKA1 ³ | Buffered clock output, bank A |
| 3 | CLKA2 ³ | Buffered clock output, bank A |
| 4 | V_{DD} | 3.3V supply |
| at4U.com 5 | GND | Ground |
| 6 | CLKB1 ³ | Buffered clock output, bank B |
| 7 | CLKB2 ³ | Buffered clock output, bank B |
| 8 | S2 ⁴ | Select input, bit 2 |
| 9 | S1 ⁴ | Select input, bit 1 |
| 10 | CLKB3 ³ | Buffered clock output, bank B |
| 11 | CLKB4 ³ | Buffered clock output, bank B |
| 12 | GND | Ground |
| 13 | V_{DD} | 3.3V supply |
| 14 | CLKA3 ³ | Buffered clock output, bank A |
| 15 | CLKA4 ³ | Buffered clock output, bank A |
| 16 | CLKOUT ³ | Buffered output, internal feedback on this pin |

Pin Description for ASM5P23S05A

| Pin # | Pin Name | Description |
|-------|-------------------|--|
| 1 | REF ² | Input reference frequency, 5V-tolerant input |
| 2 | CLK2 ³ | Buffered clock output |
| 3 | CLK1 ³ | Buffered clock output |
| 4 | GND | Ground |
| 5 | CLK3 ³ | Buffered clock output |
| 6 | V_{DD} | 3.3V supply |
| 7 | CLK4 ³ | Buffered clock output |
| 8 | CLKOUT 3 | Buffered clock output, internal feedback on this pin |

Notes:

- 2. Weak pull-down.
- 3. Weak pull-down on all outputs.
- 4. Weak pull-up on these inputs.



Absolute Maximum Ratings

| Parameter | Min | Max | Unit |
|-------------------------------------|------|-----------|------|
| Supply Voltage to Ground Potential | -0.5 | +7.0 | V |
| DC Input Voltage (Except REF) | -0.5 | VDD + 0.5 | V |
| DC Input Voltage (REF) | -0.5 | 7 | V |
| Storage Temperature | -65 | +150 | °C |
| Max. Soldering Temperature (10 sec) | | 260 | °C |
| Junction Temperature | | 150 | °C |
| Static Discharge Voltage | | 2000 | V |
| (per MIL-STD-883, Method 3015) | | | |

Note: These are stress ratings only and functional usage is not implied. Exposure to absolute maximum ratings for prolonged periods can affect device reliability.

Operating Conditions for ASM5P23S05A and ASM5P23S09A - Commercial Temperature Devices

| Parameter | Description | Min | Max | Unit |
|-----------------|---|-----|-----|------|
| V_{DD} | Supply Voltage | 3.0 | 3.6 | V |
| T _A | Operating Temperature (Ambient Temperature) | 0 | 70 | °C |
| C_L | Load Capacitance, below 100 MHz | | 30 | pF |
| C_L | Load Capacitance, from 100 MHz to 133 MHz | | 10 | pF |
| C _{IN} | Input Capacitance | | 7 | pF |



Electrical Characteristics for ASM5P23S05A and ASM5P23S09A - Commercial Temperature Devices

| Parameter | Description | Test Conditions | Min | Max | Unit |
|-----------------|----------------------------------|--------------------------------|-----|-------|------|
| V _{IL} | Input LOW Voltage 5 | | | 0.8 | V |
| V_{IH} | Input HIGH Voltage 5 | | 2.0 | | V |
| I _{IL} | Input LOW Current | $V_{IN} = 0V$ | | 50.0 | μΑ |
| I _{IH} | Input HIGH Current | $V_{IN} = V_{DD}$ | | 100.0 | μΑ |
| V_{OL} | Output LOW Voltage ⁶ | $I_{OL} = 8mA (-1)$ | | 0.4 | V |
| Mulana | | $I_{OH} = 12mA (-1H)$ | | | |
| V _{OH} | Output HIGH Voltage ⁶ | $I_{OL} = -8mA (-1)$ | 2.4 | | V |
| | | $I_{OH} = -12mA (-1H)$ | | | |
| I_{DD} | Supply Current | Unloaded outputs at 66.67 MHz, | | TBD | mA |
| | | SEL inputs at V _{DD} | | | |

Notes:

- 5. REF input has a threshold voltage of VDD/2
- 6. Parameter is guaranteed by design and characterization. Not 100% tested in production
- 7. S1 / S2 inputs are CMOS, TTL compatible inputs -

The input must toggle somewhere between 0.8 and 2.0. We guarantee the limits of 0.8 and 2.0, but can't guarantee anything tighter than that. As Vdd moves higher the toggle point will move higher, but will always stay below 2.0V. As Vdd moves lower, the toggle point will move lower, but always stay higher than 0.8V. What the 2.0V MIN Vih specification means is that you put 2.0V or a higher voltage into the device, and you will have a logic HIGH. If you put 0.8V or a lower voltage into the device, you will have a logic LOW (Vil spec = 0.8V max). It will toggle someplace in between 0.8V and 2.0V, but we don't guarantee exactly where, and the exact point will change depending upon conditions. Characterization shows we toggle at 1.1V and 1.5V (showing a little hysteresis), everything is perfect. We meet spec, plus have ~ 300mV noise immunity on the low end and ~500mV noise immunity on the high side. Under nominal conditions, with no hysteresis, most devices will toggle at about 1.5V for both high and low.

Switching Characteristics for ASM5P23S05A-1 and ASM5P23S09A-1 - Commercial Temperature Devices⁷

| Parameter | Description | Test Conditions | Min | Тур | Max | Unit |
|-------------------|---|--|------|------|---------|------|
| 1/t ₁ | Output Frequency | 30-pF load | 10 | | 100 | MHz |
| | | 10-pF load | 10 | | 133.3 3 | |
| | Duty Cycle $^{6} = (t_2/t_1) * 100$ | Measured at 1.4V, F _{OUT} = 66.67 MHz | 40.0 | 50.0 | 60.0 | % |
| t ₃ | Output Rise Time ⁶ | Measured between 0.8V and 2.0V | | | 2.50 | ns |
| t ₄ | Output Fall Time ⁶ | Measured between 2.0V and 0.8V | | | 2.50 | ns |
| t 5 | Output-to-output skew 6 | All outputs equally loaded | | | 250 | ps |
| t ₆ | Delay, REF Rising Edge to CLKOUT Rising Edge ⁶ | Measured at V _{DD} /2 | | 0 | ±350 | ps |
| t ₇ | Device-to-Device Skew ⁶ | Measured at $V_{\text{DD}}/2$ on the CLKOUT pins of the device | | 0 | 700 | ps |
| tJ | Cycle-to-cycle jitter ⁶ | Measured at 66.67 MHz, loaded outputs | | | 200 | ps |
| t _{LOCK} | PLL Lock Time ⁶ | Stable power supply, valid clock presented on REF pin | | | 1.0 | ms |

Notes:

7. All parameters specified with loaded outputs.



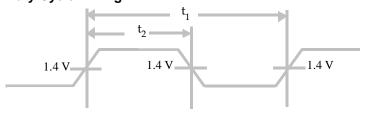
www.DataSheet4LL.com



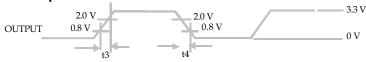
Switching Characteristics for ASM5I23S05A-1H and ASM5I23S09A-1H - Industrial Temperature Devices⁷

| Parameter | Description | Test Conditions | Min | Тур | Max | Unit |
|-------------------|-------------------------------------|---|------|------|--------|------|
| 1/t ₁ | Output Frequency | 30-pF load | 10 | | 100 | MHz |
| | | 10-pF load | 10 | | 133.33 | |
| | Duty Cycle $^{6} = (t_2/t_1) * 100$ | Measured at 1.4 V, F _{OUT} = 66.67 MHz | 40.0 | 50.0 | 60.0 | % |
| eei4JJ.com | Duty Cycle $^{6} = (t_2/t_1) * 100$ | Measured at 1.4 V, F _{OUT} < 50.0 MHz | 45.0 | 50.0 | 55.0 | |
| t3 | Output Rise Time 6 | Measured between 0.8V and 2.0V | | | 1.50 | ns |
| t4 | Output Fall Time 6 | Measured between 2.0V and 0.8V | | | 1.50 | ns |
| t5 | Output-to-output skew 6 | All outputs equally loaded | | | 250 | ps |
| t6 | Delay, REF Rising Edge to | Measured at VDD /2 | | 0 | ± 350 | ps |
| | CLKOUT Rising Edge 6 | | | | | |
| t7 | Device-to-Device Skew 6 | Measured at VDD/2 on the CLKOUT pins of | | 0 | 700 | ps |
| | | the device | | | | |
| t8 | Output Slew Rate 6 | Measured between 0.8V and 2.0V using | 1 | | | V/ns |
| | | Test Circuit #2 | | | | |
| tJ | Cycle-to-cycle jitter 6 | Measured at 66.67 MHz, loaded outputs | | | 200 | ps |
| t _{LOCK} | PLL Lock Time 6 | Stable power supply, valid clock pre sented | | | 1.0 | ms |
| | | on REF pin | | | | |

Switching Waveforms Duty Cycle Timing

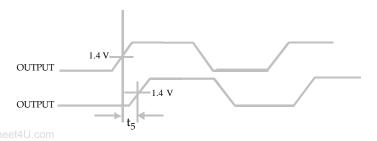


All Outputs Rise/Fall Time

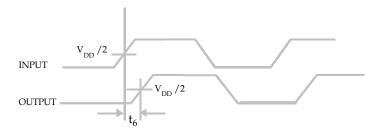




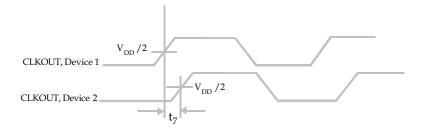
Output - Output Skew



Input - Output Propagation Delay



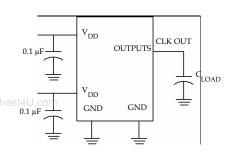
Device - Device Skew



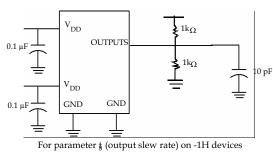


Test Circuits

Test Circuit #1



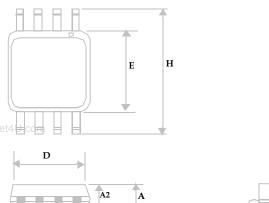
Test Circuit #2

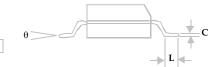




rev 2.0

Package Information: 8-lead (150-mil) SOIC



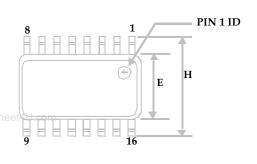


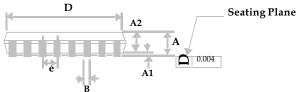
| Symbol | Dimensions in inches | | Dimensions in inches Dimensions in millimeters | |
|--------|----------------------|-------|--|------|
| | Min | Max | Min | Max |
| Α | 0.057 | 0.071 | 1.45 | 1.80 |
| A1 | 0.004 | 0.010 | 0.10 | 0.25 |
| A2 | 0.053 | 0.069 | 1.35 | 1.75 |
| В | 0.012 | 0.020 | 0.31 | 0.51 |
| С | 0.004 | 0.01 | 0.10 | 0.25 |
| D | 0.186 | 0.202 | 4.72 | 5.12 |
| Е | 0.148 | 0.164 | 3.75 | 4.15 |
| е | 0.050 | BSC | 1.27 BSC | |
| Н | 0.224 | 0.248 | 5.70 | 6.30 |
| L | 0.012 | 0.028 | 0.30 | 0.70 |
| θ | 0° | 8° | 0° | 8° |

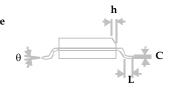


rev 2.0

Package Information: 16-lead (150 Mil) Molded SOIC



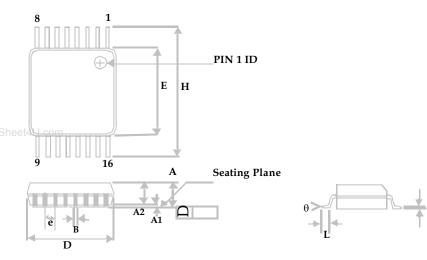




| | DIMENSIONS | | | | |
|----|------------|--------|-------------|-------|--|
| | INC | HES | MILLIMETERS | | |
| | MIN | MAX | MIN | MAX | |
| Α | 0.061 | 0.068 | 1.55 | 1.73 | |
| A1 | 0.004 | 0.0098 | 0.102 | 0.249 | |
| A2 | 0.055 | 0.061 | 1.40 | 1.55 | |
| В | 0.013 | 0.019 | 0.33 | 0.49 | |
| С | 0.0075 | 0.0098 | 0.191 | 0.249 | |
| D | 0.386 | 0.393 | 9.80 | 9.98 | |
| Е | 0.150 | 0.157 | 3.81 | 3.99 | |
| е | 0.050 BSC | | 1.27 | BSC | |
| Н | 0.230 | 0.244 | 5.84 | 6.20 | |
| h | 0.010 | 0.016 | 0.25 | 0.41 | |
| L | 0.016 | 0.035 | 0.41 | 0.89 | |
| θ | 0° | 8° | 0° | 8° | |



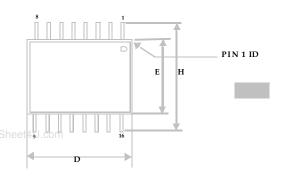
Package Information: 16-lead Thin Shrunk Small Outline Package (4.40-MM Body)

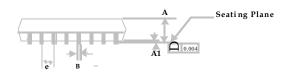


| | DIMENSION | IS (inches) | DIMENSIONS (mm) | | |
|----|-----------|-------------|-----------------|------|--|
| | MIN | MAX | MIN | MAX | |
| А | | 0.043 | | 1.10 | |
| A1 | 0.002 | 0.006 | 0.05 | 0.15 | |
| A2 | 0.003 | 0.37 | 0.85 | 0.95 | |
| В | 0.007 | 0.012 | 0.19 | 0.30 | |
| С | 0.004 | 0.008 | 0.09 | 0.20 | |
| D | 0.193 | 2.008 | 4.90 | 5.10 | |
| E | 0.169 | 0.177 | 4.30 | 4.50 | |
| е | 0.026 | BSC | 0.65 | BSC | |
| Н | 0.246 | 0.256 | 6.25 | 6.50 | |
| L | 0.020 | 0.028 | 0.50 | 0.70 | |
| θ | 0° | 8° | 0° | 8° | |



Package Information: 16-lead (150-mil) SSOP







| | DIMENSIONS (inches) DIME | | DIMENSIONS | ENSIONS (millimeters) | |
|----|--------------------------|-------|------------|-----------------------|--|
| | MIN | MAX | MIN | MAX | |
| Α | 0.049 | 0.065 | 1.245 | 1.651 | |
| A1 | 0.004 | 0.010 | 0.102 | 0.254 | |
| В | 0.008 | 0.012 | 0.203 | 0.305 | |
| С | 0.007 | 0.010 | 0.178 | 0.254 | |
| D | 0.189 | 0.197 | 4.801 | 5.004 | |
| Е | 0.150 | 0.157 | 3.81 | 3.988 | |
| е | 0.025 | BSC | 0.635 | BSC | |
| Н | 0.228 | 0.244 | 5.791 | 6.198 | |
| L | 0.016 | 0.050 | 0.406 | 1.27 | |
| θ | 0° | 8° | 0° | 8° | |



rev 2.0
Ordering Codes

| Ordering Code | Package Type | Operating Range |
|----------------------|---------------------------------|-----------------|
| ASM5P23S09A-1-16-ST | 16-pin 150-mil SOIC-TUBE | Commercial |
| ASM5I23S09A-1-16-ST | 16-pin 150-mil SOIC-TUBE | Industrial |
| ASM5P23S09A-1-16-SR | 16-pin 150-mil SOIC-TAPE & REEL | Commercial |
| ASM5I23S09A-1-16-SR | 16-pin 150-mil SOIC-TAPE & REEL | Industrial |
| ASM5P23S09A-1-16-TT | 16-pin 4.4-mm TSSOP-TUBE | Commercial |
| ASM5I23S09A-1-16-TT | 16-pin 4.4-mm TSSOP-TUBE | Industrial |
| ASM5P23S09A-1-16-TR | 16-pin 4.4-mm TSSOP-TAPE & REEL | Commercial |
| ASM5I23S09A-1-16-TR | 16-pin 4.4-mm TSSOP-TAPE & REEL | Industrial |
| ASM5P23S09A-1H-16-ST | 16-pin 150-mil SOIC-TUBE | Commercial |
| ASM5I23S09A-1H-16-ST | 16-pin 150-mil SOIC-TUBE | Industrial |
| ASM5P23S09A-1H-16-SR | 16-pin 150-mil SOIC-TAPE & REEL | Commercial |
| ASM5I23S09A-1H-16-SR | 16-pin 150-mil SOIC-TAPE & REEL | Industrial |
| ASM5P23S09A-1H-16-TT | 16-pin 4.4-mm TSSOP-TUBE | Commercial |
| ASM5I23S09A-1H-16-TT | 16-pin 4.4-mm TSSOP-TUBE | Industrial |
| ASM5P23S09A-1H-16-TR | 16-pin 4.4-mm TSSOP-TAPE & REEL | Commercial |
| ASM5I23S09A-1H-16-TR | 16-pin 4.4-mm TSSOP-TAPE & REEL | Industrial |
| ASM5P23S05A-1-08-ST | 8-pin 150-mil SOIC-TUBE | Commercial |
| ASM5I23S05A-1-08-ST | 8-pin 150-mil SOIC-TUBE | Industrial |
| ASM5P23S05A-1-08-SR | 8-pin 150-mil SOIC-TAPE & REEL | Commercial |
| ASM5I23S05A-1-08-SR | 8-pin 150-mil SOIC-TAPE & REEL | Industrial |
| ASM5P23S05A-1-08-TT | 8-pin 4.4-mm TSSOP-TUBE | Commercial |
| ASM5I23S05A-1-08-TT | 8-pin 4.4-mm TSSOP-TUBE | Industrial |
| ASM5P23S05A-1-08-TR | 8-pin 4.4-mm TSSOP-TAPE & REEL | Commercial |
| ASM5I23S05A-1-08-TR | 8-pin 4.4-mm TSSOP-TAPE & REEL | Industrial |
| ASM5P23S05A-1H-08-ST | 8-pin 150-mil SOIC-TUBE | Commercial |
| ASM5I23S05A-1H-08-ST | 8-pin 150-mil SOIC-TUBE | Industrial |
| ASM5P23S05A-1H-08-SR | 8-pin 150-mil SOIC-TAPE & REEL | Commercial |
| ASM5I23S05A-1H-08-SR | 8-pin 150-mil SOIC-TAPE & REEL | Industrial |
| ASM5P23S05A-1H-08-TT | 8-pin 4.4-mm TSSOP-TUBE | Commercial |
| ASM5I23S05A-1H-08-TT | 8-pin 4.4-mm TSSOP-TUBE | Industrial |
| ASM5P23S05A-1H-08-TR | 8-pin 4.4-mm TSSOP-TAPE & REEL | Commercial |
| ASM5I23S05A-1H-08-TR | 8-pin 4.4-mm TSSOP-TAPE & REEL | Industrial |

Licensed under US patent Nos 5,488,627 and 5,631,920. Preliminary datasheet. Specification subject to change without notice.



ww.DataSheet4U.con



Alliance Semiconductor Corporation 2595, Augustine Drive, Santa Clara, CA 95054 Tel# 408-855-4900

Fax: 408-855-4999 www.alsc.com Copyright © Alliance Semiconductor All Rights Reserved Part Number: ASM5P23S09A ASM5P23S05A

Document Version: 2.0

© Copyright 2003 Alliance Semiconductor Corporation. All rights reserved. Our three-point logo, our name and Intelliwatt are trademarks or registered trademarks of Alliance. All other brand and product names may be the trademarks of their respective companies. Alliance reserves the right to make changes to this document and its products at any time without notice. Alliance assumes no responsibility for any errors that may appear in this document. The data contained herein represents Alliance's best data and/or estimates at the time of issuance. Alliance reserves the right to change or correct this data at any time, without notice. If the product described herein is under development, significant changes to these specifications are possible. The information in this product data sheet is intended to be general descriptive information for potential customers and users, and is not intended to operate as, or provide, any quarantee or warrantee to any user or customer. Alliance does not assume any responsibility or liability arising out of the application or use of any product described herein, and disclaims any express or implied warranties related to the sale and/or use of Alliance products including liability or warranties related to fitness for a particular purpose, merchantability, or infringement of any intellectual property rights, except as express agreed to in Alliance's Terms and Conditions of Sale (which are available from Alliance). All sales of Alliance products are made exclusively according to Alliance's Terms and Conditions of Sale. The purchase of products from Alliance does not convey a license under any patent rights, copyrights; mask works rights, trademarks, or any other intellectual property rights of Alliance or third parties. Alliance does not authorize its products for use as critical components in life-supporting systems where a malfunction or failure may reasonably be expected to result in significant injury to the user, and the inclusion of Alliance products in such life-supporting systems implies that the manufacturer assumes all risk of such use and agrees to indemnify Alliance against all claims arising from such use.

8 30 2004